

Features

- ✧ Frequency range : 1MHz to 170MHz
- ✧ SMD seam sealing ceramic package
- ✧ Supply voltage : 1.8V ~ 3.3V
- ✧ CMOS output
- ✧ Tri-state function available
- ✧ External dimensions (mm)
L : 7.0 x W : 5.0 x H : 1.3
- ✧ RoHS compliant & Pb free

Applications

- ✧ Networking, Server, Storage
- ✧ Wireless communications
- ✧ Fibre channel, Ethernet, SATA, SAS, PCI-E, USB, WLAN, xDSL, xPON
- ✧ PC mainboard, Notebook, HDD, SSD, Graphics card, Computer peripherals
- ✧ Audio, Video, Gaming, Printer, DSC, IP CAM, Consumer products

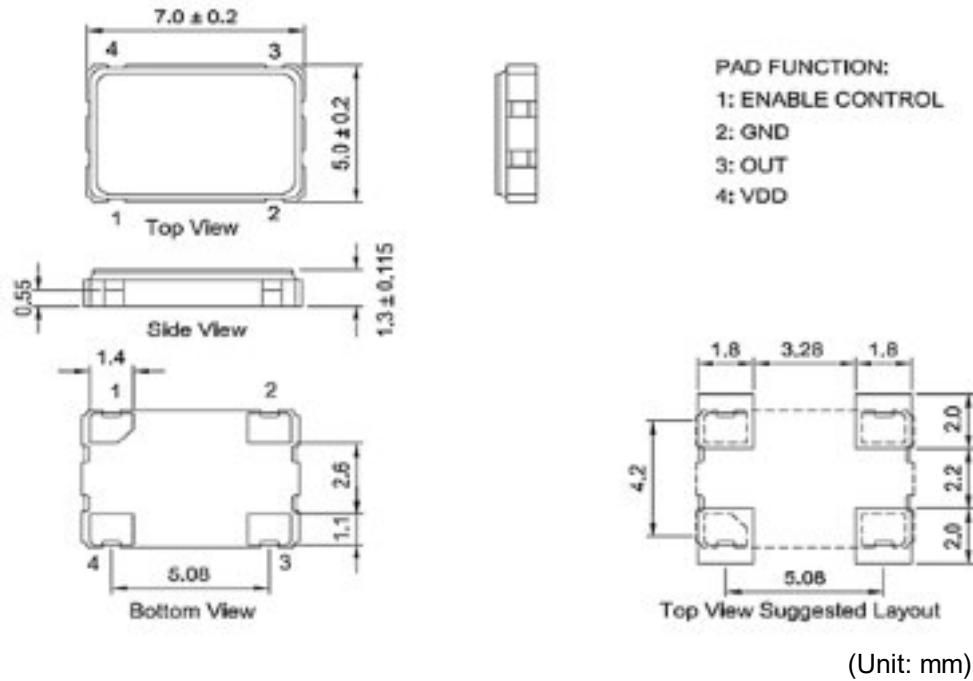
Electrical Characteristics

Item	7W	Conditions
Frequency Range (F_0)	1MHz ~ 170MHz	
Frequency Stability (F_{stab})	$\pm 50\text{ppm}$, $\pm 30\text{ppm}$, $\pm 25\text{ppm}$	Note [1]
Operating Temperature Range (T_{OTR})	$-40^\circ\text{C} \sim +85^\circ\text{C}$	
Supply Voltage (V_{DD})	1.8V, 2.5V, 3.3V	$V_{DD} \pm 10\%$
Current Consumption (I_{DD})	10 mA Max.	1MHz ~ 75MHz
	20 mA Max.	75MHz ~ 170MHz
Output Type	CMOS	
Output Load (C_L)	15 pF	
Output Voltage High (V_{OH})	90% V_{DD} Min.	
Output Voltage Low (V_{OL})	10% V_{DD} Max.	
Rise & Fall Time (T_r / T_f)	8 ns Max.	10% ~ 90% of V_{DD}
Duty Cycle	40% ~ 60%	
Start-up Time	5 ms Max.	
Enable Voltage High, Logic "1"	70% V_{DD} Min.	Input to Pin1 Note [2]
Enable Voltage Low, Logic "0"	30% V_{DD} Max.	
Phase Jitter, RMS	1 ps Max.	Note [3]
Aging (F_{aging})	± 3 ppm Max.	at $25^\circ\text{C} \pm 3^\circ\text{C}$, first year
Storage Temperature Range (T_{STR})	$-55^\circ\text{C} \sim +125^\circ\text{C}$	

Notes:

- [1] Inclusive of frequency tolerance at 25°C , 1st year aging at 25°C , and variations over operating temperature, supply voltage, and load.
- [2] Output will be enabled if Pin1 is Logic "1" or open; Output will be disabled if Pin1 is Logic "0".
- [3] Freq. 10MHz~40MHz, integrated 12kHz~5MHz; Freq. >40MHz, integrated 12kHz~20MHz.

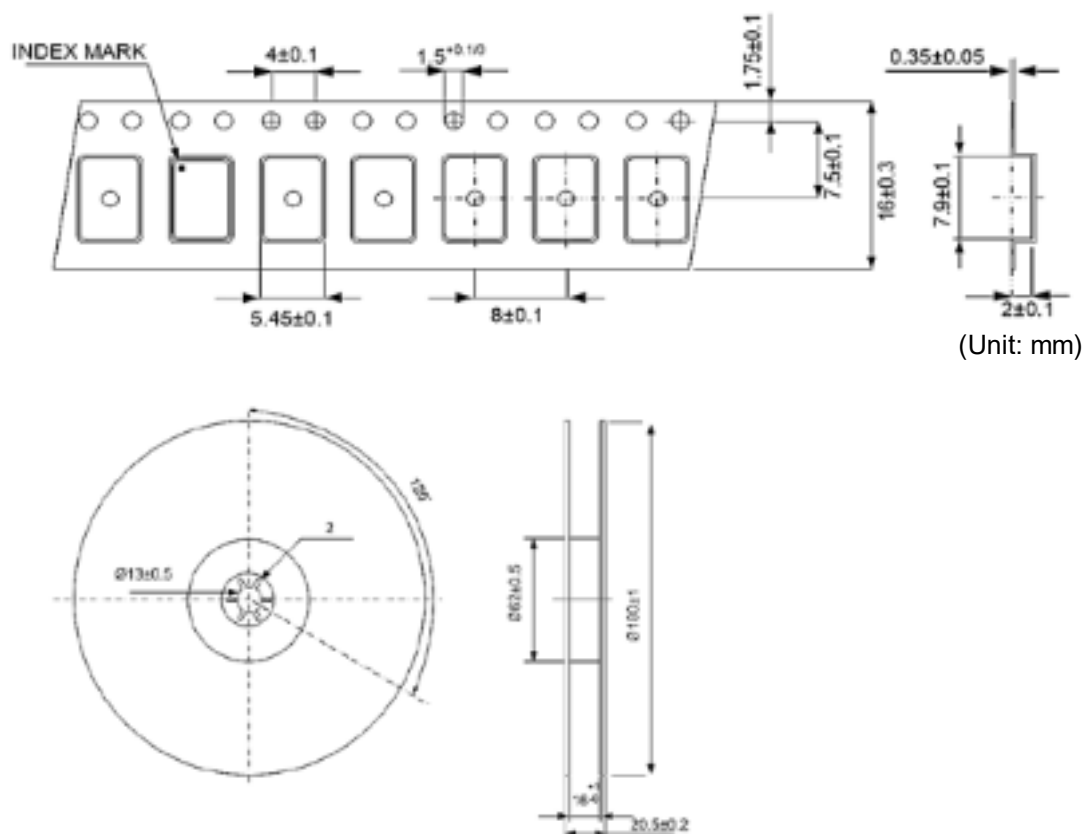
Dimensions



Ordering Information

7W	-	30.000M	B	E	-	T
		Frequency in Hz			Packaging Method	
		Please contact us for available frequencies			T Tape & Reel	
		Supply Voltage			Frequency Stability	
		B 3.3 V			A ± 25 ppm (-10°C ~ +70°C)	
		C 2.5 V			D ± 25 ppm (-40°C ~ +85°C)	
		D 1.8 V			E ± 50 ppm (-40°C ~ +85°C)	

Packing



Reflow Profile

Solder melting point : 220°C ± 10°C, 60 sec. Min.

Peak temperature : 260°C ± 10°C, 10 sec. Min.

